Application Serial No.: 10/577,140 Office Action dated: January 21, 2010

Response to Office Action dated: April 21, 2010

AMENDMENT TO THE ABSTRACT

Please amend the Abstract of the Disclosure as follows:

The present invention is directed to a [[A]] distributor (1) for distributing a flow of cooling fluid over <u>one or more</u> surface(s) (3) to be cooled. The distributor <u>has Has-a</u> housing (13) <u>that may be manufactured in a single piece together</u> with inlet (8) and outlet (9) manifolds and a plurality of flow cells (26, 27, 28, 29). <u>Manufacturing the housing in this manner makes Makes-it easier and more cost effective to manufacture the distributor (1). The flow cells (26, 27, 28, 29) may be connected in parallel between the manifolds (8, 9), and may . May be adapted to cool two or more multiple surfaces (3) simultaneously. The present invention is also directed to Also-a fluid-coolable unit comprising <u>a</u> the distributor (1), which may be suitable. Suitable for removing heat from an electronic circuit, such as integrated circuit or CPU.</u>